

# XRF Rework Paste Flux Technical Specifications

Bokar International XRF Paste Flux has been developed especially for for SMT Rework and Repair of PCB's using Lead Free Solders. It can be used also for all other manual soldering with wires or solder pastes made of Lead Free Alloys. The XRF flux paste is based on modified rosins and includes a slight composition of halogenated activators. This is the guarantee for superior soldering results and also for the best no-clean properties. Minimal residue after soldering has very high S.I.R. values and temperature stability, it is dry (not tacky).

## **PHYSICAL PROPERTIES:**

Density : ca. 1.07 g/cm<sup>3</sup>  
Solid content : ca. 44%  
PH-value : ca. 5-6

**VISCOSITY** (Pa.s) +/-10% measured with Brookfield RVT-DV-II

At 25°C comes to 145.

## **STORAGE**

At room temperature 12 months

## **APPLICATION**

The Rework Flux has been designed generally for applications by syringes, but it is suitable for all other kinds of dosages. The used amount of Rework Flux should be completely remelted for the best dry residues. Please to use everytime the most, possible, smallest quantity of RF2 for the soldering.

## **PACKING**

Syringes: 5ccm,10ccm

## **Available P/N :**



**XRF-10M – Lead Free Rework Paste Flux in 10cc syringe with manual plunger.**

**XRF-10A – Lead Free Rework Paste Flux in 10cc syringe for use with manual or auto dispensers.**



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